Product data sheet

1. General description

Planar passivated Silicon Controlled Rectifier (SCR) in a TO220 plastic package intended for use in applications requiring very high inrush current capability, high thermal cycling performance and high junction temperature capability ($T_{i(max)} = 150$ °C).

2. Features and benefits

- High junction operating temperature capability (T_{i(max)} = 150 °C)
- · Very high current surge capability
- · Planar passivated for voltage ruggedness and reliability
- High turn-on current rise dl_T/dt = 200 A/μs
- High noise immunity dV_D/dt = 500 V/µs up to 150 °C
- High thermal cycling performance
- High voltage capability

3. Applications

- · Ignition circuits
- Protection circuits e.g. SMPS inrush current
- Motor control circuits and starters
- Voltage regulation
- Solid state relays
- High junction operating temperature capability (T_{j(max)} = 150 °C)

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values	Unit
Absolute r	maximum rating			
V_{DRM}	repetitive peak off-state voltage		800	V
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 128°C; Fig. 1; Fig. 2; Fig. 3	40	А
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 10 \text{ ms}$; Fig. 4; Fig. 5	450	А
		half sine wave; $T_{j(init)} = 25 ^{\circ}C$; $t_p = 8.3 \text{ms}$	495	А
T _j	junction temperature		150	°C

Symbol	Parameter	Conditions		Min	Тур	Max	Unit		
Static cha	Static characteristics								
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C}; Fig. 7$		-	-	15	mA		
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>		-	-	60	mA		
V _T	on-state voltage	I _T = 80 A; T _j = 25 °C; <u>Fig. 10</u>		-	-	1.6	V		
Dynamic	Dynamic characteristics								
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T_j = 150 °C; (V_{DM} = 67% of V_{DRM}); exponential waveform; gate open circuit		500	-	-	V/µs		

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	mb	. N
2	А	anode		A K G
3	G	gate		sym037
mb	A	mounting base; connected to anode		

6. Ordering information

Table 3. Ordering information

Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
TYN40-800T	TO220	TYN40-800TQ	Tube	50	SOT78	13-Jun-2008

7. Marking

Table 4. Marking codes

Type number	Marking codes			
	Assembly factory: d	Assembly factory: A		
TYN40-800T	TYN40 800T PJdxxxx xx	TYN40 800T PJAxxxx xx		

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{DRM}	repetitive peak off-state voltage		800	V
V_{RRM}	repetitive peak reverse voltage		800	V
I _{T(AV)}	average on-state current	half sine wave; T _{mb} ≤ 128°C;	25	А
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 128°C; Fig. 1; Fig. 2; Fig. 3	40	А
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)} = 25 ^{\circ}\text{C}$; $t_p = 10 \text{ms}$; Fig. 4; Fig. 5	450	А
		half sine wave; $T_{j(init)} = 25 ^{\circ}\text{C}$; $t_p = 8.3 \text{ms}$	495	А
l ² t	I ² t for fusing	t _p = 10ms; sine wave	1012.5	A ² s
dl _⊤ /dt	rate of rise of on-state current	I _G = 30mA	200	A/µs
I _{GM}	peak gate current		5	А
V_{GM}	peak gate voltage		5	V
P_{GM}	peak gate power		20	W
$P_{G(AV)}$	average gate power	over any 20 ms period	0.5	W
T _{stg}	storage temperature		-40 to 150	°C
T _j	junction temperature		150	°C

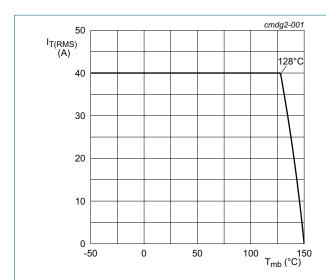
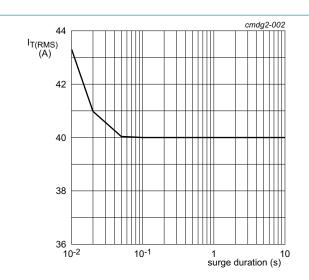
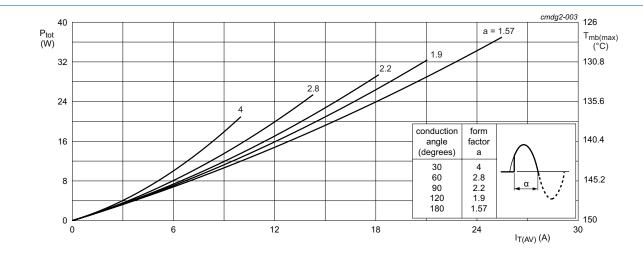


Fig. 1. RMS on-state current as a function of mounting base temperature; maximum values



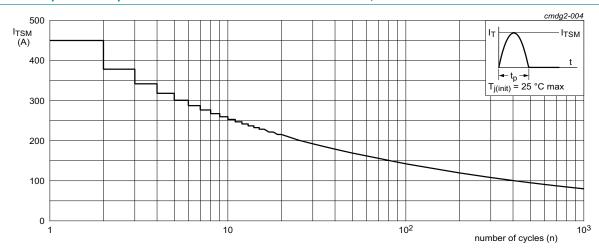
f = 50 Hz; T_{mb} = 128 °C Fig. 2. RMS on-state current as a function of surge duration; maximum values



 α = conduction angle

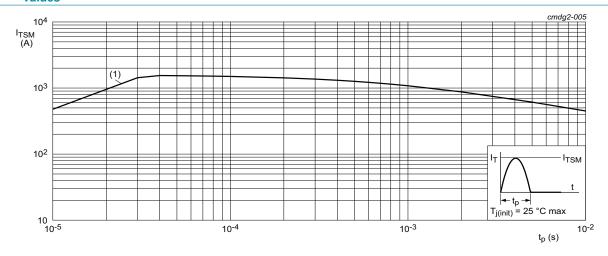
a = form factor = $I_{T(RMS)}$ / $I_{T(AV)}$

Fig. 3. Total power dissipation as a function of RMS on-state current; maximum values



f = 50 Hz

Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values



 $t_p \le 10 \text{ ms}$; (1) $dI_T/dt \text{ limit}$

Fig. 5. Non-repetitive peak on-state current as a function of pulse duration; maximum values

WeEn Semiconductors TYN40-800T

SCF

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 6	-	-	0.6	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W

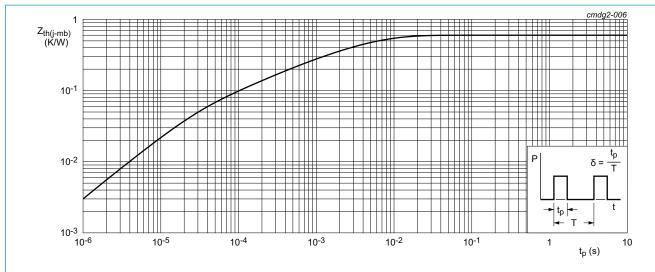
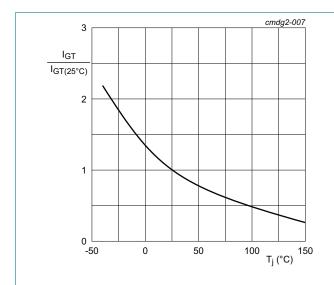


Fig. 6. Transient thermal impedance from junction to mounting base as a function of pulse duration

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C}; Fig. 7$	-	-	15	mA
IL	latching current	$V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T_j = 25 \text{ °C}; Fig. 8$	-	-	80	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	60	mA
V _T	on-state voltage	I _T = 80 A; T _j = 25 °C; <u>Fig. 10</u>	-	-	1.6	V
V _{GT} gate trigger voltage		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C};$ Fig. 11	-	0.7	1.2	V
		$V_D = 400 \text{ V}; I_T = 0.1 \text{ A}; T_j = 150 ^{\circ}\text{C}$	0.25	0.5	-	V
I _D	off-state current	V _D = 800 V; T _j = 150 °C	-	-	2	mA
I _R	reverse current	V _D = 800 V; T _j = 150 °C	-	-	2	mA
Dynamic o	characteristics				1	
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T_j = 150 °C; (V_{DM} = 67% of V_{DRM}); exponential waveform; gate open circuit	500	-	-	V/µs
t _{gt}	gate-controlled turn-on time	$I_{TM} = 80 \text{ A}; V_D = 800 \text{ V}; I_G = 100 \text{ mA}; (dI_G/dt)_M = 0.2 \text{ A/}\mu\text{s}; T_j = 25 \text{ °C}$		2	-	μs
time		V_{DM} = 536 V; T_j = 150 °C; I_{TM} = 40 A; V_R = 25 V; dV_D/dt = 50 V/ μ s; $(dI_T/dt)_M$ = 30 A/ μ s; $(V_{DM}$ = 67% of $V_{DRM})$		70	-	μs





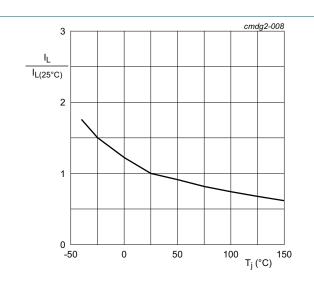
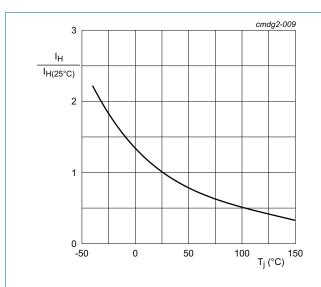
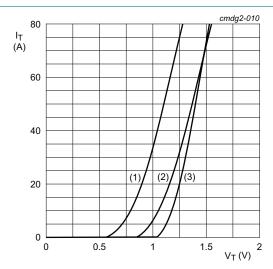


Fig. 8. Normalized latching current as a function of junction temperature





 $V_o = 1.036 \text{ V}; R_s = 0.0066 \Omega$

(1) T_i = 150 °C; typical values

(2) $T_j = 150$ °C; maximum values

(3) T_j = 25 °C; maximum values

Fig. 9. Normalized holding current as a function of junction temperature

Fig. 10. On-state current as a function of on-state voltage

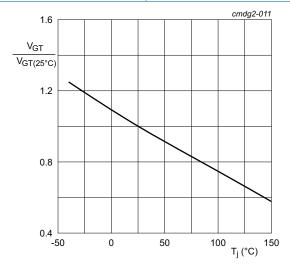
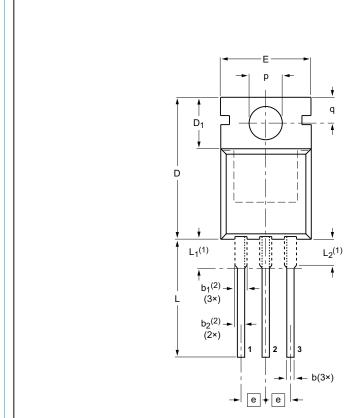


Fig. 11. Normalized gate trigger voltage as a function of junction temperature

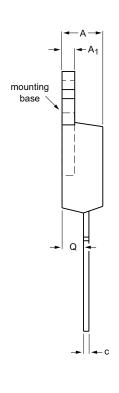
SOT78

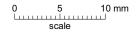
11. Package outline

Assembly factory: d & A



Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB





DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁	b	b ₁ ⁽²⁾	b ₂ ⁽²⁾	С	D	D ₁	E	е	L	L ₁ (1)	L ₂ ⁽¹⁾ max.	р	q	Q
mm	4.7 4.1	1.40 1.25	0.9 0.6	1.6 1.0	1.3 1.0	0.7 0.4	16.0 15.2	6.6 5.9	10.3 9.7	2.54	15.0 12.8	3.30 2.79	3.0	3.8 3.5	3.0 2.7	2.6 2.2

Notes

- Lead shoulder designs may vary.
 Dimension includes excess dambar.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	EC JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT78		3-lead TO-220AB	SC-46		08-04-23 08-06-13	

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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